## **MO10H603**6"**MO**100H603

# 9-Bit Latch ECL to TTL Translator

#### Description

The MC10H/100H603 is a 9-bit, dual supply ECL to TTL translator. Devices in the ON Semiconductor 9-bit translator series utilize the 28-lead PLCC for optimal power pinning, signal flow-through and electrical performance.

The devices feature a 48 mA TTL output stage, and AC performance is specified into both a 50 pF and 200 pF load capacitance. Latching is controlled by Latch Enable (LEN), and Master Reset (MR) resets the latches. A HIGH on OEECL sends the outputs into the high impedance state. All control inputs are ECL level.

The 10H version is compatible with MECL  $10H^{\mathsf{TM}}$  ECL logic levels. The 100H version is compatible with 100K levels.

#### **Features**

- 9-Bit Ideal for Byte-Parity Applications
- 3-State TTL Outputs
- Flow-Through Configuration
- Extra TTL and ECL Power Pins to Minimize Switching Noise
- Dual Supply
- 6.0 ns Max Delay into 50 pF, 12 ns into 200 pF (all Outputs Switching)
- PNP TTL Inputs for Low Loading
- Pb-Free Packages are Available\*



#### ON Semiconductor®

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PLCC-28 FN SUFFIX CASE 776

#### **MARKING DIAGRAM\***



xxx = 10 or 100

A = Assembly Location

WL = Wafer Lot YY = Year WW = Work Week G = Pb-Free Package

\*For additional marking information, refer to Application Note AND8002/D.

#### **ORDERING INFORMATION**

See detailed ordering and shipping information in the package dimensions section on page 4 of this data sheet.

<sup>\*</sup>For additional information on our Pb-Free strategy and soldering details, please download the ON Semiconductor Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

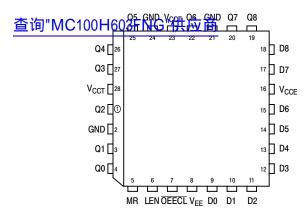


Figure 1. PLCC-28 Pinout (Top View)

#### Table 1. PIN NAMES

PIN	FUNCTION
GND V <sub>CCE</sub> V <sub>CCT</sub> V <sub>EE</sub> D0 – D8 Q0 – Q8 OEECL LEN MR	TTL Ground (0 V)  ECL V <sub>CC</sub> (0 V)  TTL Supply (+5.0 V)  ECL Supply (-5.2/-4.5 V)  Data Inputs (ECL)  Data Outputs (TTL)  3-State Control (ECL)  Latch Enable (ECL)  Master Reset (ECL)

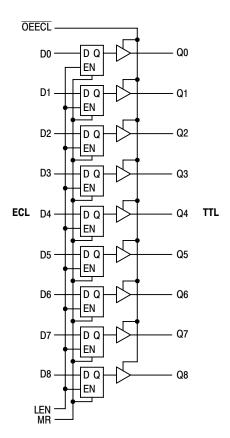


Figure 2. Logic Diagram

Table 2. TRUTH TABLE

D	LEN	MR	OEECL	ø
L	L	L	L	L
Н	L	L	L	Н
X	Н	L	L	$Q_0$
X	Х	Н	L	L
Х	Х	Х	Н	Z

#### **查钟 ECL(DO) CHARACTERISTICS** (CCT = 5.0 V ± 10%; V<sub>EE</sub> = -5.2 V ± 5%

		0°C		25°C		85		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit
I <sub>EE</sub>	Power Supply Current		-64		-64		-64	mA
I <sub>INH</sub> I <sub>INL</sub>	Input HIGH Current Input LOW Current	0.5	255	0.5	175	0.5	175	μ <b>Α</b> μ <b>Α</b>
V <sub>IH</sub> V <sub>IL</sub>	Input HIGH Voltage Input LOW Voltage	-1170 -1950	-840 -1480	-1130 -1950	-810 -1480	-1060 -1950	-720 -1445	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### 100H ECL DC CHARACTERISTICS: $V_{CCT} = 5.0 \text{ V} \pm 10\%$ ; $V_{EE} = -4.2 \text{ V}$ to -5.5 V

		0°C		25°C		85		
Symbol	Parameter	Min	Max	Min	Max	Min	Max	Unit
I <sub>EE</sub>	Power Supply Current		-63		-64		-68	mA
I <sub>INH</sub> I <sub>INL</sub>	Input HIGH Current Input LOW Current	0.5	255	0.5	175	0.5	175	μ <b>Α</b> μ <b>Α</b>
V <sub>IH</sub> V <sub>IL</sub>	Input HIGH Voltage Input LOW Voltage	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	-1165 -1810	-880 -1475	mV

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### TTL DC CHARACTERISTICS: $V_{CCT} = 5.0 \text{ V} \pm 10\%$ ; $V_{EE} = -5.2 \text{ V} \pm 5\%$ (10H); $V_{EE} = -4.2 \text{ V}$ to -5.5 V (100H)

			0°C		25°C		85°C		
Symbol	Parameter	Condition	Min	Max	Min	Max	Min	Max	Unit
I <sub>CCH</sub>	Power Supply Current			110		110		110	mA
I <sub>CCL</sub>				110		110		110	
I <sub>CCZ</sub>	Power Supply Current			110		110		110	
I <sub>OS</sub>	Output Short Circuit Current	V <sub>OUT</sub> = 0 V	-100	-225	-100	-225	-100	-225	mA
I <sub>OZH</sub> I <sub>OZL</sub>	Output Disable Current HIGH Output Disable Current LOW	V <sub>OUT</sub> = 2.7 V V <sub>OUT</sub> = 0.5 V		50 -50		50 -50		50 -50	μΑ
V <sub>OHT</sub>	Output HIGH Voltage	I <sub>OH</sub> = -3.0 mA I <sub>OH</sub> = -15 mA	2.5 2.0		2.5 2.0		2.5 2.0		V
V <sub>OLT</sub>	Output LOW Voltage	I <sub>OL</sub> = 48 mA		0.55		0.55		0.55	V

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

查令的HARAGTERISTICS (2/6世 京商 V ± 10%; VEE = -5.2 V ± 5% (10H); VEE = -4.2 V to -5.5 V (100H)

				0°C		25°C		85°C		
Symbol	Parameter		Condition	Min	Max	Min	Max	Min	Max	Unit
t <sub>PLH</sub> t <sub>PHL</sub>	Propagation Delay to Output	D	C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	3.0 6.4	6.0 12	3.0 6.4	6.0 12	3.0 6.4	6.0 12	ns ns
		LEN	C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	3.5 7.0	6.5 13	3.5 7.0	6.5 13	3.5 7.0	6.5 13	ns ns
		MR	C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	3.0 6.0	6.0 12	3.0 6.0	6.0 12	3.0 6.0	6.0 12	ns ns
t <sub>PLZ</sub> t <sub>PHZ</sub>	Output Disable Time		C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	2.5 4.2	6.5 13	2.5 4.2	6.5 13	2.5 4.2	6.5 13	ns ns
t <sub>PZL</sub> t <sub>PZH</sub>	Output Enable Time		C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	2.0 4.0	5.0 10	2.0 4.0	5.0 10	2.0 4.0	5.0 10	ns ns
ts	Setup Time	D to LEN		1.5		1.5		1.5		ns
t <sub>h</sub>	Hold Time	D to LEN		0.8		0.8		0.8		ns
t <sub>w(L)</sub>	LEN Pulse Width, LOW	-		2.0		2.0		2.0		ns
t <sub>R</sub> t <sub>F</sub>	Output Rise/Fall Time 1.0 V - 2.0 V		C <sub>L</sub> = 50 pF C <sub>L</sub> = 200 pF	0.2 0.2	1.2 3.0	0.2 0.2	1.2 3.0	0.2 0.2	1.2 3.0	ns ns

NOTE: Device will meet the specifications after thermal equilibrium has been established when mounted in a test socket or printed circuit board with maintained transverse airflow greater than 500 lfpm. Electrical parameters are guaranteed only over the declared operating temperature range. Functional operation of the device exceeding these conditions is not implied. Device specification limit values are applied individually under normal operating conditions and not valid simultaneously.

#### **ORDERING INFORMATION**

Device	Package	Shipping <sup>†</sup>
MC10H603FN	PLCC-28	37 Units / Rail
MC10H603FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC10H603FNR2	PLCC-28	500 / Tape & Reel
MC10H603FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel
MC100H603FN	PLCC-28	37 Units / Rail
MC100H603FNG	PLCC-28 (Pb-Free)	37 Units / Rail
MC100H603FNR2	PLCC-28	500 / Tape & Reel
MC100H603FNR2G	PLCC-28 (Pb-Free)	500 / Tape & Reel

<sup>†</sup>For information on tape and reel specifications, including part orientation and tape sizes, please refer to our Tape and Reel Packaging Specifications Brochure, BRD8011/D.

# 查询"MC100H603FNG"供应商esource Reference of Application Notes

AN1405/D - ECL Clock Distribution Techniques

AN1406/D - Designing with PECL (ECL at +5.0 V)

AN1503/D - ECLinPS™ I/O SPiCE Modeling Kit

AN1504/D - Metastability and the ECLinPS Family

AN1568/D - Interfacing Between LVDS and ECL
AN1672/D - The ECL Translator Guide

AND8001/D - Odd Number Counters Design

AND8002/D - Marking and Date Codes

AND8020/D - Termination of ECL Logic Devices

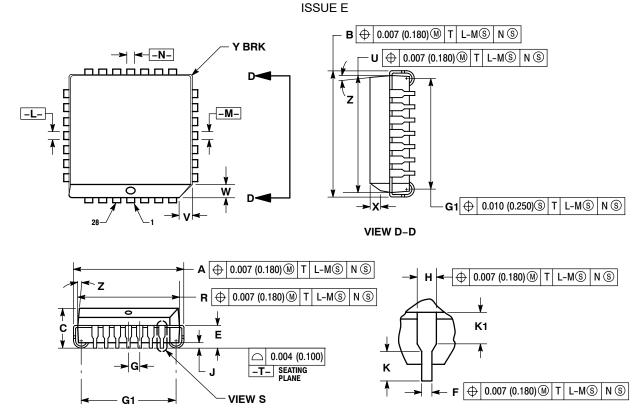
AND8066/D - Interfacing with ECLinPS

AND8090/D - AC Characteristics of ECL Devices

#### 查询"MC100H603FNG"供应商

#### PACKAGE DIMENSIONS

#### PLCC-28 **FN SUFFIX** PLASTIC PLCC PACKAGE CASE 776-02



⊕ 0.010 (0.250)® T L-M® N®

- DATUMS -L-, -M-, AND -N- DETERMINED
   WHERE TOP OF LEAD SHOULDER EXITS
- PLASTIC BODY AT MOLD PARTING LINE.

  2. DIMENSION G1, TRUE POSITION TO BE MEASURED AT DATUM -T-, SEATING PLANE.

  3. DIMENSIONS R AND U DO NOT INCLUDE
- MOLD FLASH. ALLOWABLE MOLD FLASH IS 0.010 (0.250) PER SIDE. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
   CONTROLLING DIMENSION: INCH.
   THE PACKAGE TOP MAY BE SMALLER THAN
- THE PACKAGE BOTTOM BY UP TO 0.012 (0.300). DIMENSIONS R AND U ARE DETERMINED AT THE OUTERMOST EXTREMES OF THE PLASTIC BODY EXCLUSIVE OF MOLD FLASH, TIE BAR BURRS, GATE BURRS AND INTERLEAD FLASH, BUT INCLUDING ANY MISMATCH BETWEEN THE TOP AND BOTTOM OF THE PLASTIC BODY.
- DIMENSION H DOES NOT INCLUDE DAMBAR PROTRUSION OR INTRUSION. THE DAMBAR PROTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE GREATER THAN 0.037 (0.940). THE DAMBAR INTRUSION(S) SHALL NOT CAUSE THE H DIMENSION TO BE SMALLER THAN 0.025 (0.635).

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.485	0.495	12.32	12.57
В	0.485	0.495	12.32	12.57
C	0.165	0.180	4.20	4.57
Е	0.090	0.110	2.29	2.79
F	0.013	0.019	0.33	0.48
G	0.050	BSC	1.27	BSC
Н	0.026	0.032	0.66	0.81
7	0.020		0.51	
K	0.025		0.64	
R	0.450	0.456	11.43	11.58
J	0.450	0.456	11.43	11.58
٧	0.042	0.048	1.07	1.21
W	0.042	0.048	1.07	1.21
Х	0.042	0.056	1.07	1.42
Υ		0.020		0.50
Z	2 °	10°	2°	10°
G1	0.410	0.430	10.42	10.92
K1	0.040		1.02	

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